N-Channel Power MOSFET 100 V, 23 A, 56 m Ω , Logic Level

Features

- Low R_{DS(on)}
- 100% Avalanche Tested
- AEC-Q101 Qualified
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_{.I} = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	100	V
Gate-to-Source Voltage - Continuous			V_{GS}	±20	V
Continuous Drain Current	Steady	T _C = 25°C	I _D	23	Α
Current	State	T _C = 100°C		16	
Power Dissipation	Steady State	T _C = 25°C	P _D	83	W
Pulsed Drain Current	t _p = 10 μs		I _{DM}	80	Α
Operating and Storage Temperature Range			T _J , T _{stg}	-55 to +175	°C
Source Current (Body Diode)			Is	23	Α
Single Pulse Drain-to-Source Avalanche Energy (V_{DD} = 50 Vdc, V_{GS} = 10 Vdc, $I_{L(pk)}$ = 23 A, L = 0.3 mH, R_G = 25 Ω)			E _{AS}	79	mJ
Lead Temperature for Soldering Purposes, 1/8" from Case for 10 Seconds			TL	260	°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Case (Drain) - Steady State	$R_{\theta JC}$	1.8	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	39	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

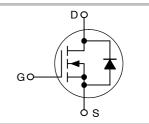
 Surface mounted on FR4 board using 1 sq in pad size, (Cu Area 1.127 sq in [2 oz] including traces).



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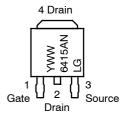
V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX	
100 V	56 mΩ @ 4.5 V	23 A	
100 V	52 mΩ @ 10 V	20 A	





DPAK CASE 369AA STYLE 2

MARKING DIAGRAM & PIN ASSIGNMENT



6415ANL = Device Code
Y = Year
WW = Work Week
G = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

$\textbf{ELECTRICAL CHARACTERISTICS} \ (T_J = 25^{\circ}C \ unless \ otherwise \ noted)$

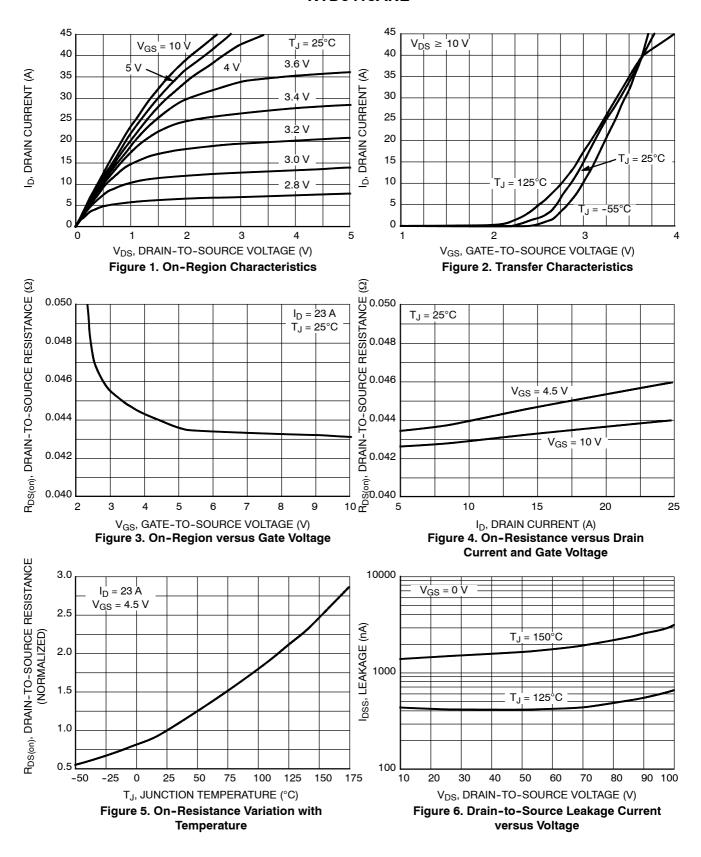
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS			L		1	1	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V, I}_D = 250 \mu\text{A}$ $V_{GS} = 0 \text{ V, I}_D = 250 \mu\text{A, T}_J = -40 ^{\circ}\text{C}$		100 92			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				115		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 100 V	$T_J = 25$ °C $T_J = 125$ °C			1.0 100	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 1	±20 V			±100	nA
ON CHARACTERISTICS (Note 2)			·			<u>I</u>	
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 2$	50 μΑ	1.0		2.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				4.8		mV/°C
Drain-to-Source On-Resistance	R _{DS(on)}	V _{GS} = 4.5 V, I _D =	10 A		44	56	mΩ
		V _{GS} = 10 V, I _D =	10 A		43	52	1
Forward Transconductance	9 _{FS}	V _{DS} = 5.0 V, I _D = 10 A			24		S
CHARGES, CAPACITANCES AND GAT	E RESISTANO	CE					
Input Capacitance	C _{ISS}				1024		pF
Output Capacitance	Coss	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 25 V			156		
Reverse Transfer Capacitance	C _{RSS}				70		1
Total Gate Charge	Q _{G(TOT)}				20		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 80 V, I _D = 23 A			1.1		
Gate-to-Source Charge	Q_{GS}	v _{GS} = 4.5 v, v _{DS} = 60	v, ID = 23 A		3.1		1
Gate-to-Drain Charge	Q_{GD}				14		1
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 80 V, I _D = 23 A			35		nC
SWITCHING CHARACTERISTICS (Note	∋ 3)						
Turn-On Delay Time	t _{d(on)}				11		ns
Rise Time	t _r	V _{GS} = 4.5 V, V _{DD} =	= 80 V,		91		
Turn-Off Delay Time	t _{d(off)}	$I_D = 23 A, R_G = 6$	5.1 Ω		40		
Fall Time	t _f				71		
DRAIN-SOURCE DIODE CHARACTER	ISTICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 23 A	$T_J = 25$ °C $T_J = 125$ °C		0.87 0.74	1.2	V
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V, dl}_S/\text{dt} = 100 \text{ A/}\mu\text{s,}$ $I_S = 23 \text{ A}$			64		ns
Charge Time	Ta				40		1
Discharge Time	T _b				24		1
Reverse Recovery Charge	Q _{RR}				152		nC

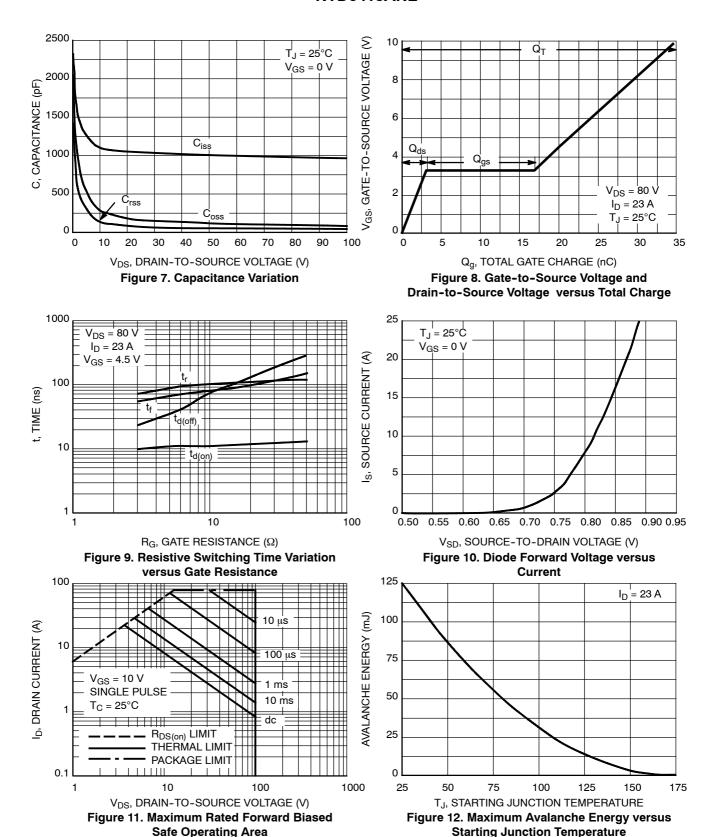
ORDERING INFORMATION

Device	Package	Shipping [†]
NTD6415ANLT4G	DPAK (Pb-Free)	2500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperatures.





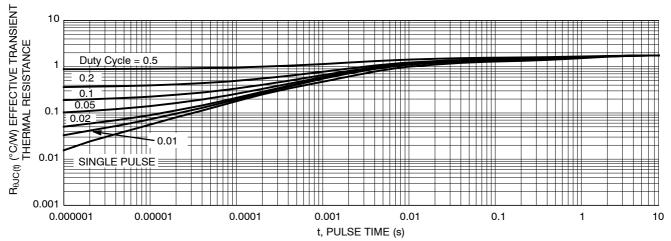
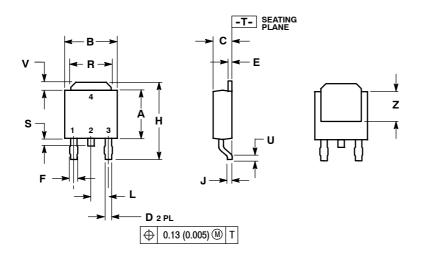


Figure 13. Thermal Response

PACKAGE DIMENSIONS

DPAK (SINGLE GUAGE)

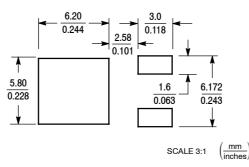
CASE 369AA-01 ISSUF A



- 1. DIMENSIONING AND TOLERANCING
- PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIM	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.235	0.245	5.97	6.22
В	0.250	0.265	6.35	6.73
С	0.086	0.094	2.19	2.38
D	0.025	0.035	0.63	0.89
E	0.018	0.024	0.46	0.61
F	0.030	0.045	0.77	1.14
Н	0.386	0.410	9.80	10.40
J	0.018	0.023	0.46	0.58
L	0.090	BSC	2.29	BSC
R	0.180	0.215	4.57	5.45
S	0.024	0.040	0.60	1.01
U	0.020		0.51	
٧	0.035	0.050	0.89	1.27
Z	0.155		3.93	

- STYLE 2: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN
- SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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